SDLS072

SN54190, SN54191, SN54LS190, SN54LS191, SN74190, SN74191, SN74LS190, SN74LS191 WAN COUNTERS WITH DOWNUP MODE CONTROL

SYNCHRONOUS UP/DOWN COUNTERS WITH DOWN/UP MODE CONTROL DECEMBER 1972 - REVISED MARCH 1988

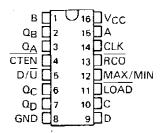
- Counts 8-4-2-1 BCD or Binary
- Single Down/Up Count Control Line
- Count Enable Control Input
- · Ripple Clock Output for Cascading
- Asynchronously Presettable with Load Control
- · Parallel Outputs
- Cascadable for n-Bit Applications

-		TYPICAL	
	AVERAGE	MAXIMUM	TYPICAL
TYPE	PROPAGATION	CLOCK	POWER
	DELAY	FREQUENCY	DISSIPATION
190,191	20 ns	25MHz	325mW
'i \$190.'L\$191	20 ns	25MHz	100mW

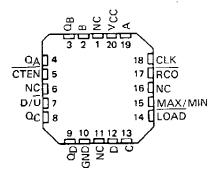
description

The '190, 'LS190, '191, and 'LS191 are synchronous, reversible up/down counters having a complexity of 58 equivalent gates. The '191 and 'LS191 are 4-bit binary counters and the '190 and 'LS190 are BCD counters. Synchronous operation is provided by having all flipflops clocked simultaneously so that the outputs change coincident with each other when so instructed by the steering logic. This mode of operation eliminates the output counting spikes normally associated with asynchronous (ripple clock) counters.

SN54190, SN54191, SN54LS190. SN54LS191 . . . J PACKAGE SN74190, SN74191 . . . N PACKAGE SN74LS190, SN74LS191 . . . D OR N PACKAGE (TOP VIEW)



SN54LS190, SN54LS191 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

The outputs of the four master-slave flip-flops are triggered on a low-to-high transition of the clock input if the enable input is low. A high at the enable input inhibits counting. Level changes at the enable input should be made only when the clock input is high. The direction of the count is determined by the level of the down/up input. When low, the counter count up and when high, it counts down. A false clock may occur if the down/up input changes while the clock is low. A false ripple carry may occur if both the clock and enable are low and the down/up input is high during a load pulse.

These counters are fully programmable; that is, the outputs may be preset to either level by placing a low on the load input and entering the desired data at the data inputs. The output will change to agree with the data inputs independently of the level of the clock input. This feature allows the counters to be used as modulo-N dividers by simply modifying the count length with the preset inputs.

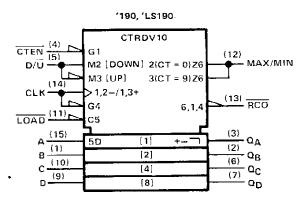
The clock, down/up, and load inputs are buffered to lower the drive requirement which significantly reduces the number of clock drivers, etc., required for long parallel words.

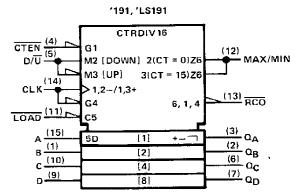
Two outputs have been made available to perform the cascading function: ripple clock and maximum/minimum count. The latter output produces a high-level output pulse with a duration approximately equal to one complete cycle of the clock when the counter overflows or underflows. The ripple clock output produces a low-level output pulse equal in width to the low-level portion of the clock input when an overflow or underflow condition exists. The counters can be easily cascaded by feeding the ripple clock output to the enable input of the succeeding counter if parallel clocking is used, or to the clock input if parallel enabling is used. The maximum/minimum count output can be used to accomplish look-ahead for high-speed operation.

Series 54' and 54LS' are characterized for operation over the full military temperature range of -55° C to 125° C; Series 74' and 74LS' are characterized for operation from 0° C to 70° C.

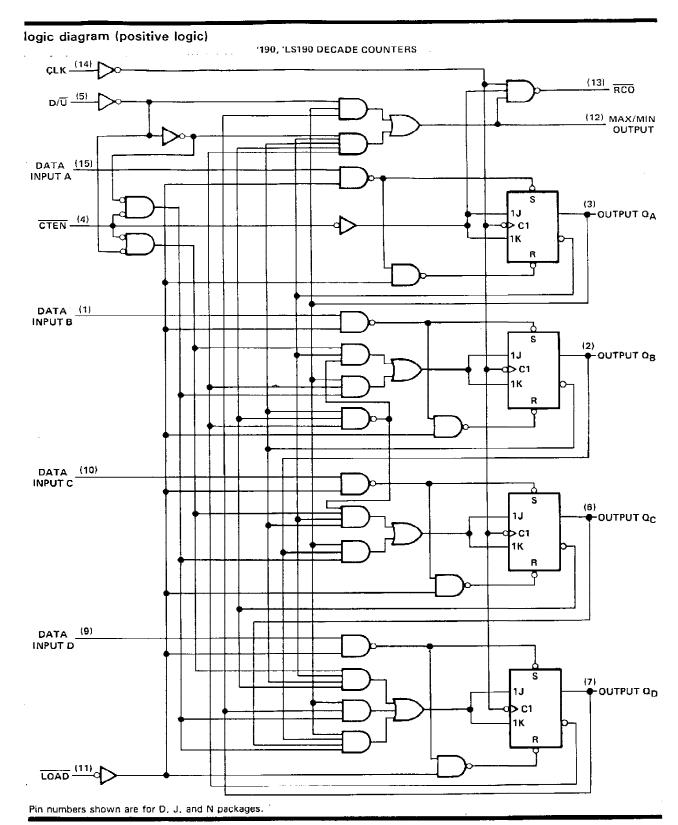


logic symbols†





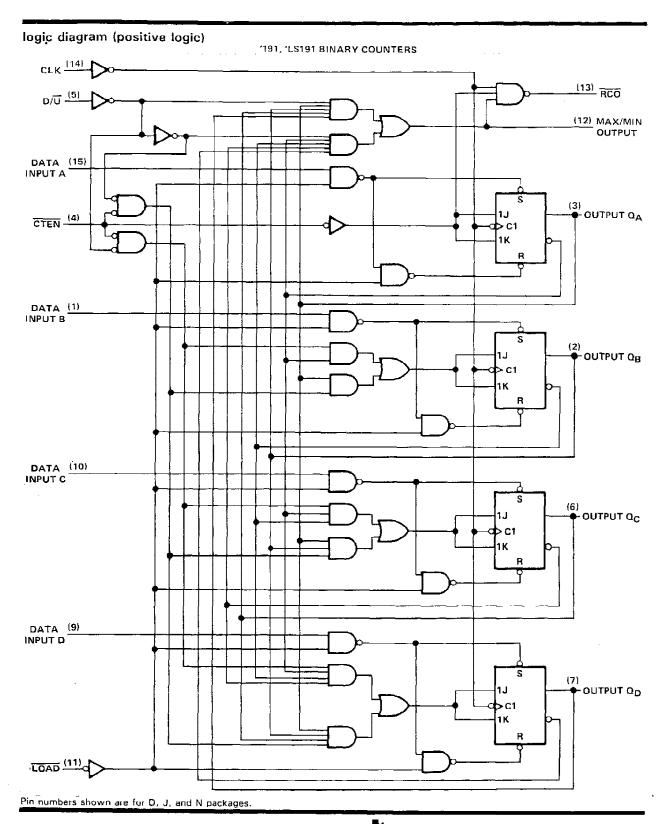
 $^{^{\}dagger}$ These symbols are accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, and N packages.





POST OFFICE BOX 655012 • DALLAS, TEXAS 75265

SN54191, SN54LS191, SN74191, SN74LS191 SYNCHRONOUS UP/DOWN COUNTERS WITH DOWN/UP MODE CONTROL

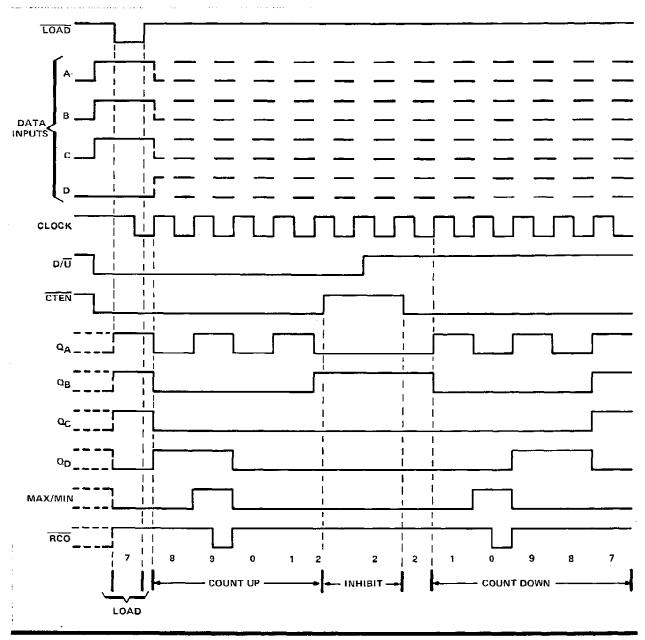


'190, 'LS190 DECADE COUNTERS

typical load, count, and inhibit sequences

Illustrated below is the following sequence:

- 1. Load (preset) to BCD seven.
- 2. Count up to eight, nine (maximum), zero, one, and two.
- 3. Inhibit.
- 4. Count down to one, zero (minimum), nine, eight, and seven.

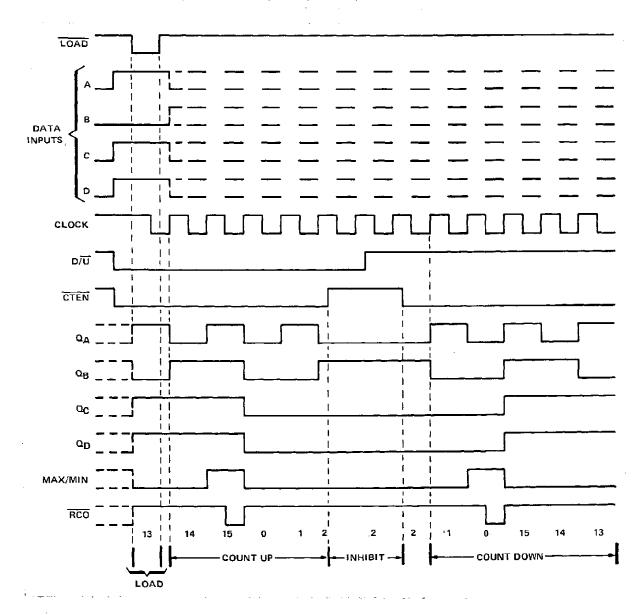


'191, 'LS191 BINARY COUNTERS

typical load, count, and inhibit sequences

Illustrated below is the following sequence:

- 1. Load (preset) to binary thirteen.
- 2. Count up to fourteen, fifteen (maximum), zero, one, and two.
- 3. Inhibit,
- 4. Count down to one, zero (minimum), fifteen, fourteen, and thirteen.



SN54190, SN54191, SN54LS190, SN54LS191, SN74LS190, SN74LS191, SN74LS190, SN74LS191 SYNCHRONOUS UP/DOWN COUNTERS WITH DOWN/UP MODE CONTROL

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)
Input voltage: SN54', SN74' Circuits
SN54LS', SN74LS' Circuits
Operating free-air temperature range: SN54', SN54LS' Circuits
SN74′, SN74LS′ Circuits
Storage temperature range

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

			SN54	190, SN	54191	SN74	190, SN	74191	UNIT
			MIN	MOM	MAX	MIN	NOM	MAX	3 0.011
Vcc	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
ЮН	High-level output	current			- 0.8			8.0	mA
lor	Law-level output	current			16			16	mA
f _{clack}	Input clock frequ	ency	0		20	0		20	MHz
tw(clock)	Width of clock in	put pulse	25			25			ns
tw(load)	Width of load inp	ut pulse	35			35			ns
•	Setup time	Data, high or low (See Figure 1 and 2)	20			20			ns
t _{su}	Setup time	Load inactive state	20			20			''3
^t hold	Data hold time		0			0			ns
TA	Operating free-air	temperature	- 55		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS†	SN54190, SN54191			SN74	UNIT		
		TEST CONDITIONS	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNII
٧ıн	High-level input voltage	V _{CC} = MIN	2			2			V
VIL	Low-level input voltage	VCC = MIN	 		0.8	_		0.8	V
Vικ	Input clamp voltage	V _{CC} = MIN, I _I = −12 mA			-1.5			-1.5	V
Vон	High-level output voltage	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OH} = -0.8 mA	2.4	3.4		2.4	3.4		٧
VOL	Low-level output voltage	VCC = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OL} = 16 mA		0.2	0.4		0.2	0.4	V
ij	High-level input current at maximum input voltage	V _{CC} = MAX, V _I = 5.5 V		· ·	1		· · ·	1	mA
ЧН	High-level input current at any input except enable				40			40	μΑ
Iн	High-level input current at enable input	VCC = MAX, V ₁ = 2.4 V			120			120	μA
¹₁∟	Low-level input current at any input except enable				-1.6		-	-1.6	πА
IIL	Low-level input current at enable input	VCC = MAX. VI = 0.4 V			-4.8			-4.8	mA
los	Short-circuit output current §	V _{CC} = MAX	-20		-65	-18		-65	mA
Icc	Supply current	V _{CC} = MAX, See Note 2	<u> </u>	65	99		65	105	mA

 $^{^\}dagger$ For conditions shown as MAX or MIN, use appropriate value specified under recommended operating conditions,

NOTE 2: 1_{CC} is measured with all inputs grounded and all outputs open,

[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.

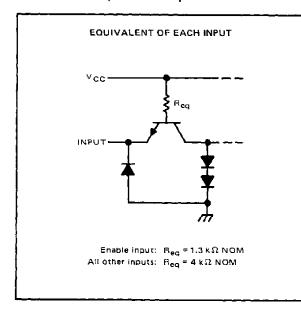
 $[\]S$ Not more than one output should be shorted at a time,

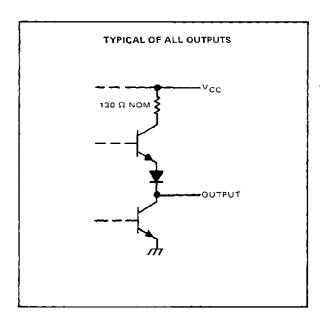
SN54190, SN54191, SN74190, SN74191 SYNCHRONOUS UP/DOWN COUNTERS WITH DOWN/UP MODE CONTROL

switching characteristics, V_{CC} = 5 V, T_A = 25°C

	FROM	то		·	190, 1	91	
PARAMETER [†]	(INPUT)	(OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f _{max}				20	25		MHz
tPLH	Load	0. 0- 0- 0-	1		22	33	ns
^t PHL		$\Omega_A, \Omega_B, \Omega_C, \Omega_D$			33	50	1115
^T PLH	Dota A D C D	Q_A, Q_B, Q_C, Q_D	1		14	22	
^t PHL	CLK	υ _Α , υ _Β , υ _C , υ _D			35	50	ns
[†] PLH		Max/Min	$C_L \approx 15 pF$, $R_L = 400 \Omega$, See Figures 1 and 3 thru 7		13	20	
^t PHL					16	24	ns
[†] PLH			Deeringules Faile 5 tille 1		16	24	ns
tpHL	CLK		1		24	36	
tPLH					28	42	
[†] PHL	CLK				37	52	ns
^t PLH	D/Ū		1		30	45	
†PHL	D/O		1		30	45	ns
[†] PLH	D/Ü	B.7. (0.1)]	{	21	33	
^T PHL	1 0/0	Max/Min			22	33	ns

schematics of inputs and outputs





[†] f_{max} ≡ maximum clock frequency tp_{LH} ≡ propagation delay time, low-to-high-level output tp_{HL} = propagation delay time, high-to-low-level output

SN54LS190, SN54LS191, SN74LS190, SN74LS191 SYNCHRONOUS UP/DOWN COUNTERS WITH DOWN/UP MODE CONTROL

recommended operating conditions

		\$N54L\$190 \$N74L\$190 \$N54L\$191 \$N74L\$191		UNIT				
		MIN	NOM	MAX	MIN	NOM	MAX]
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
Тон	High-level output current			- 0.4			- 0.4	mΑ
lOL	Low-level output current			4			8	mΑ
fclack	Clock frequency	0		20	0		20	MHz
tw(clock)	Width of clock input pulse	25			25			ns
tw(load)	Width of load input pulse	35			35			ns
t _{su}	Data setup time (See Figures 1 and 2)	20			20			ns
t _{su}	Load inactive state setup time	30		-	30			ns
t _h	Data hold time	5			5			ns
th	Enable hold time	0			0			ns
^t enable	Count enable time (see Note 3)	40	_		40		-	ns
TA	Operating free-air temperature	- 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS [†]		SN54LS190 SN54LS191			SN74LS190 SN74LS191			UNIT	
		Í				MIN	TYP [‡]	MAX	MIN	TYP‡	MAX	
VIΗ	High-level input voltag	je				2			2			٧
VIL	Low-level input voltag	e	-				-	0.7			0.8	V
VIK	Input clamp voltage		V _{CC} = MIN,	1 ₁ =18 mA				-1.5			-1.5	V
Voн	High-level output volta	age	V _{CC} = MIN, V _{1L} = V _{1L} max,	V _{IH} = 2 V, , I _{OH} =400 μA		2.5	3.4		2.7	3.4		v
VOL	Low-level output volta	ege .	V _{CC} = MIN, V _{1L} = V _{1L} max		$I_{OL} = 4 \text{ mA}$ $I_{OL} = 8 \text{ mA}$		0.25	0.4		0.25	0.4	V
l ₁	High-level input	Enable	V _{CC} = MAX,	V ₁ = 7 V				0.3			0.3	mA
	input voltage	Others	, ACC - IMAX	01-70				0.1			0.1	1112
	High-level	Enable					_	60			60	
ΉΗ	input current	Others	ACC = MAX'	CC = MAX, V _I = 2.7 V				20			20	μΔ
1.,	Low-level	Enable	1/ = 240 V	V. = 0.4 V				-1.2			-1.2	A
1 L	input current	Others	V _{CC} = MAX,	V - 0.4 V			_	-0.4			-0.4	mA
los	Short-circuit output of	urrent §	V _{CC} = MAX,			-20		-100	-20		-100	mA
Icc	Supply current		V _{CC} = MAX,	See Note 2			20	35		20	35	mA

[†]For conditions shown as MAX or MIN, use appropriate value specified under recommended operating conditions for the applicable device type.

 $^{^{\}ddagger}$ All typical values are at $V_{CC} \approx 5 \text{ V, T}_{A} = 25^{\circ}\text{C}$.

Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTES: 2. I_{CC} is measured with all inputs grounded and all outputs open.

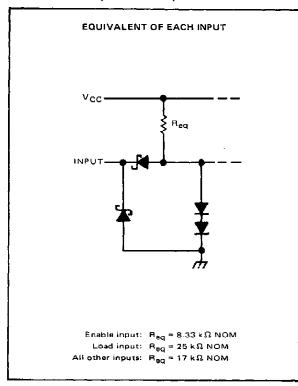
^{3.} Minimum count enable time is the interval immediately preceeding the listing edge of the clock pulse during which interval the count enable input must be low to ensure counting.

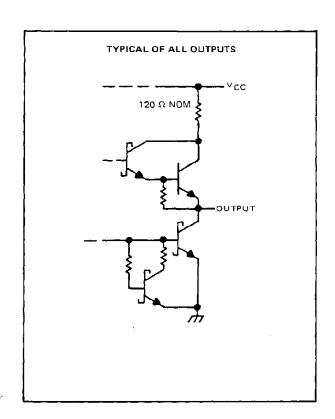
SN54LS190, SN54LS191, SN74LS190, SN74LS191 SYNCHRONOUS UP/DOWN COUNTERS WITH DOWN/UP MODE CONTROL

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

	FROM	то		'LS	190, 'L	S191	
PARAMETER†	(INPUT)	(OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f _{max}				20	25		MHZ
†PLH	Load	QA, QB, QC, QD	1 	(22	3 3	ns
[†] PHL	Load	MA. dg. dc. db	1		33	50	1 113
tPLH	Data A, B, C, D	$\Omega_{A}, \Omega_{B}, \Omega_{C}, \Omega_{D}$	1		20	32	ns
†PHL	Data A, B, C, B	u _A , a _B , a _C , a _D	<u> </u>	Ĺ	27	40	i
tPLH.	0.14	RCO	$C_1 = 15 pF, R_1 = 2 k\Omega,$		13	20	1
tPHL	CLK	NGO	See Figures 1 and 3 thru 7		16	24	√ ns l
†PLH	CLK	QA, QB, QC, QD		16	24	ns	
^t PHL] CLK				24	36	115
tPLH.	01.16				28	42	ns
†PHL	CLK	IVI 3 1/11/IIII	:		37	52	''3
†PLH		RCO			30	45	ns
(PHL	D/Ũ				30	45] "
^t PLH	~		1		21	33	
^t PHL	טֿעם 🕆	Max/Min			22	33	ns
^t PLH		700			21	33	Ī <u>.</u> .
tpHL	CTEN	RCO	_		22	33	ns

schematics of inputs and outputs





 $^{^{\}dagger}\,f_{max}$ = maximum clock frequency tpLH = propagation delay time, low-to-high-level output

tpHL = propagation delay time, high-to-low-level output

PARAMETER MEASUREMENT INFORMATION

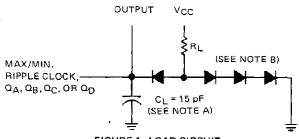
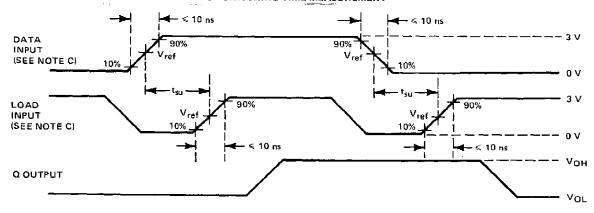
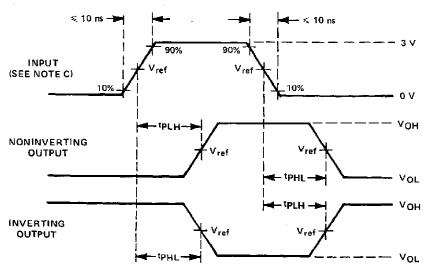


FIGURE 1-LOAD CIRCUIT
FOR SWITCHING TIME MEASUREMENT



FIGUTE 2-DATA SETUP TIME VOLTAGE WAVEFORMS



See waveform sequences in figures 4 through 7 for propagation times from a specific input to a specific output. For simplication, pulse rise times, reference levels, etc., have not been shown in figures 4 through 7.

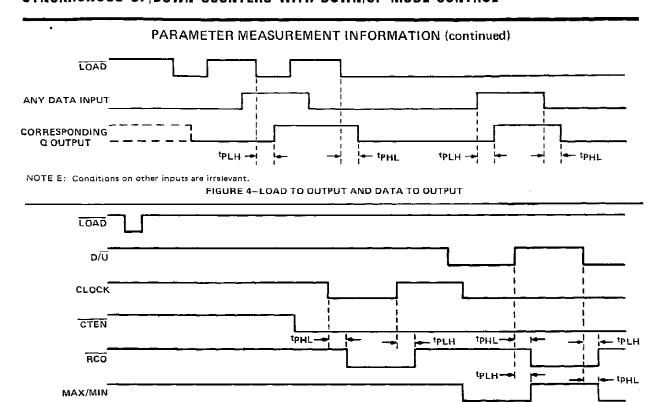
FIGURE 3-GENERAL VOLTAGE WAVEFORMS FOR PROPAGATION TIMES

NOTES: A. Ct includes probe and jig capacitance.

- B. All diodes are 1N3064 or equivalent.
- C. The input pulses are supplied by generators having the following characteristics: Z_{out} = 50 Ω , duty cycle \leq 50%, PRR \leq 1 MHz.
- D. Vref = 1.5 V for '190 and '191; 1.3 V for 'L\$190 and 'L\$191.



POST OFFICE BOX 655012 . DALLAS, TEXAS 75265



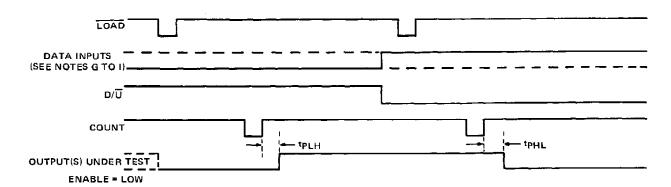
NOTE F: All data inputs are low,

FIGURE 5-ENABLE TO RIPPLE CLOCK, CLOCK TO RIPPLE CLOCK, DOWN/UP TO RIPPLE CLOCK, AND DOWN/UP TO MAX/MIN

SN54190, SN54191, SN54LS190, SN54LS191, SN74LS190, SN74LS190, SN74LS190, SN74LS190 SYNCHRONOUS UP/DOWN COUNTERS WITH DOWN/UP MODE CONTROL

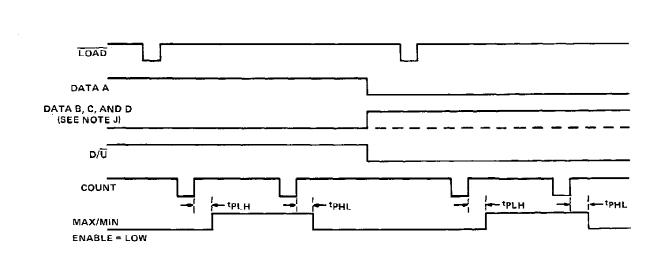
PARAMETER MEASUREMENT INFORMATION (continued)

switching characteristics (continued)



- NOTES: G. To test Q_A , Q_B , and Q_C outputs of '190 and 'LS190: Data inputs A, B, and C are shown by the solid line. Data input D is shown by the dashed line.
 - H. To test Q_D output of '190 and 'LS190: Data inputs A and D are shown by the solid line. Data inputs B and C are held at the low logic level.
 - 1. To test Q_A , Q_B , Q_C , and Q_D outputs of '191 and 'L\$191: All four data inputs are shown by the solid line.

FIGURE 6-CLOCK TO OUTPUT



NOTE J: Data inputs B and C are shown by the dashed line for the '190 and 'LS190 and the solid line for the '191 and 'LS191: Data input D is shown by the solid line for both devices.

FIGURE 7-CLOCK TO MAX/MIN



IMPORTANT NOTICE

Texas Instruments (TI) reserves the right to make changes to its products or to discontinue any semiconductor product or service without notice, and advises its customers to obtain the latest version of relevant information to verify, before placing orders, that the information being relied on is current.

TI warrants performance of its semiconductor products and related software to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

Certain applications using semiconductor products may involve potential risks of death, personal injury, or severe property or environmental damage ("Critical Applications").

TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, INTENDED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT APPLICATIONS, DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS.

Inclusion of TI products in such applications is understood to be fully at the risk of the customer. Use of TI products in such applications requires the written approval of an appropriate TI officer. Questions concerning potential risk applications should be directed to TI through a local SC sales office.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards should be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance, customer product design, software performance, or infringement of patents or services described herein. Nor does TI warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used.

Copyright © 1996, Texas Instruments Incorporated

IMPORTANT NOTICE

Texas Instruments (TI) reserves the right to make changes to its products or to discontinue any semiconductor product or service without notice, and advises its customers to obtain the latest version of relevant information to verify, before placing orders, that the information being relied on is current.

TI warrants performance of its semiconductor products and related software to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

Certain applications using semiconductor products may involve potential risks of death, personal injury, or severe property or environmental damage ("Critical Applications").

TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, INTENDED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT APPLICATIONS, DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS.

Inclusion of TI products in such applications is understood to be fully at the risk of the customer. Use of TI products in such applications requires the written approval of an appropriate TI officer. Questions concerning potential risk applications should be directed to TI through a local SC sales office.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards should be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance, customer product design, software performance, or infringement of patents or services described herein. Nor does TI warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used.

Copyright © 1996, Texas Instruments Incorporated